

High Voltage Power MOSFET

IXTT12N150 IXTH12N150

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

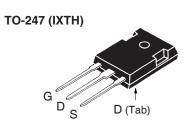
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Symbol	Test Conditions	Maximum F	Ratings
V _{DSS}	$T_{J} = 25^{\circ}C$ to 150°C	1500	V
V _{DGR}	$T_{\rm J}=25^{\circ}{\rm C}$ to 150°C, $R_{\rm GS}=1{\rm M}\Omega$	1500	V
V _{GSS}	Continuous	±30	V
V _{GSM}	Transient	±40	V
I _{D25}	T _c = 25°C	12	A
I _{DM}	$T_{\rm c}$ = 25°C, Pulse Width Limited by $T_{\rm JM}$	40	А
I _A	T _c = 25°C	6	A
E _{AS}	$T_{c} = 25^{\circ}C$	750	mJ
dv/dt	$I_{S} \leq I_{DM}, V_{DD} \leq V_{DSS}, T_{J} \leq 150^{\circ}C$	5	V/ns
P _D	$T_{c} = 25^{\circ}C$	890	W
T,		- 55 +150	°C
T _{JM}		150	°C
T _{stg}		- 55 +150	°C
T,	1.6mm (0.062 in.) From Case for 10s	300	°C
T _{SOLD}	Plastic Body for 10s	260	°C
M _d	Mounting Torque	1.13 / 10	Nm/lb.in.
Weight	TO-268	4.0	g
	TO-247	6.0	g

Symbol $(T_J = 25^{\circ}C, U)$	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Value Max	
BV _{DSS}	$V_{GS} = 0V, I_{D} = 1mA$	1500			V
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	2.5		4.5	V
I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			25 500	μ Α μ Α
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \bullet I_{D25}, Note 1$			2.2	Ω

 $V_{DSS} = 1500V$ $I_{D25} = 12A$ $R_{DS(op)} \le 2.2\Omega$





D (Tab)

G = Gate D = DrainS = Source Tab = Drain

Features

- International Standard Packages
- Molding Epoxies Weet UL 94 V-0 Flammability Classification
- Fast Intrinsic Diode
- Low Package Inductance

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High Voltage Power Supplies
- Capacitor Discharge
- Pulse Circuits



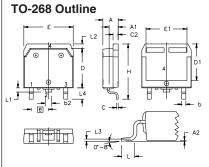
Symbol (T _J = 25°C, U	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.
g _{fs}	$V_{DS} = 20V, I_{D} = 0.5 \bullet I_{D25}, Note 1$	8	13	S
C _{iss}			3720	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		240	pF
C _{rss}			80	pF
t _{d(on)}	Resistive Switching Times		26	ns
t _r	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D2S}$		16	ns
$\mathbf{t}_{d(off)}$			53	ns
t _f	$R_{\rm G} = 2\Omega$ (External)		14	ns
$Q_{g(on)}$			106	nC
Q _{gs}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		17	nC
\mathbf{Q}_{gd}			50	nC
R _{thJC}				0.14 °C/W
R _{thCS}	TO-247		0.21	°C/W

Source-Drain Diode

Symbol $(T_J = 25^{\circ}C,$	Test Conditions Unless Otherwise Specified)	Charac Min.	cteristic Typ.	Values Max.	
I _s	$V_{GS} = 0V$			12	Α
I _{sm}	Repetitive, Pulse Width Limited by T_{JM}			48	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.4	V
t _{rr}	L − 6Δ -di/dt − 100Δ/μs		1.2		μs
I _{RM}	$I_F = 6A, -di/dt = 100A/\mu s$ $V_R = 100V, V_{GS} = 0V$		24.5		Α
Q _{RM}	v _R = 100 v, v _{GS} = 0 v		14.8		μC

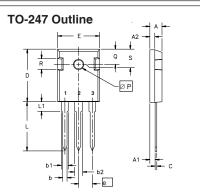
Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

IXTH12N150



Terminals: 1 - Gate 2,4 - Drain 3 - Source

MY2	INCHES		MILLIMETERS	
2114	MIM	MAX	MIN	MAX
Α	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
С	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
Е	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
е	.215 BSC		5.45 BSC	
Н	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010	BSC	0.25 BSC	
L4	.150	.161	3.80	4.10

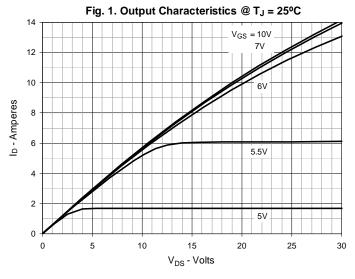


Terminals: 1 - Gate 2 - Drain 3 - Source

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
Α	4.7	5.3	.185	.209
A ₁	2.2	2.54	.087	.102
A ₂	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b,	1.65	2.13	.065	.084
b ₂	2.87	3.12	.113	.123
С	.4	.8	.016	.031
D	20.80	21.46	.819	.845
Е	15.75	16.26	.610	.640
е	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

30





8 7 V_{GS} = 10V - 6V - 6V - 5V - 5V - 5V - V_{DS} - Volts

Fig. 3. $R_{DS(on)}$ Normalized to I_D = 6A Value vs. Junction Temperature

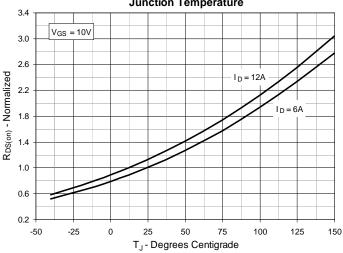


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 6A Value vs.

Drain Current

Fig. 2. Output Characteristics @ T_J = 125°C

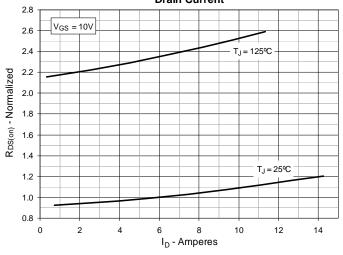
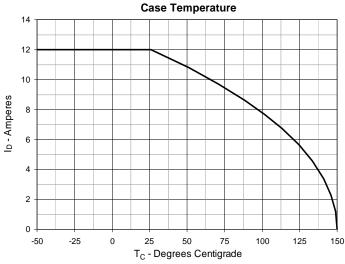
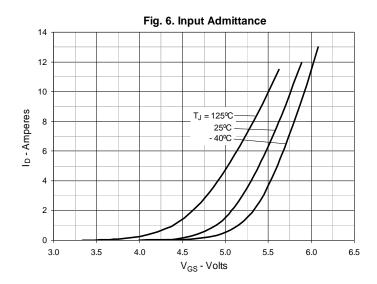
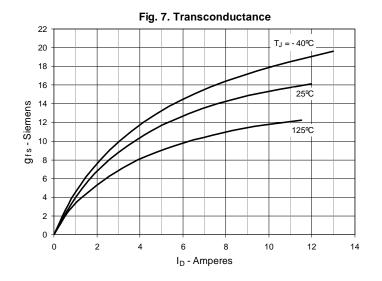


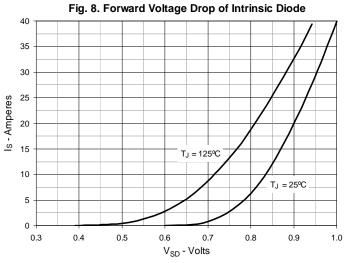
Fig. 5. Maximum Drain Current vs.

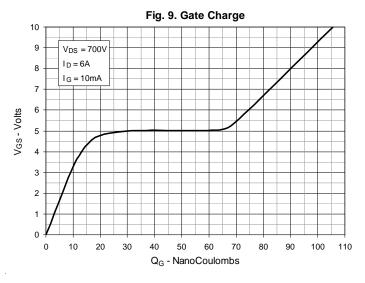


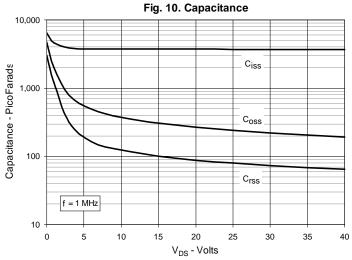


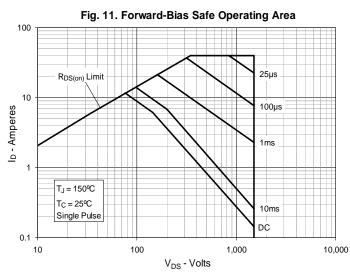


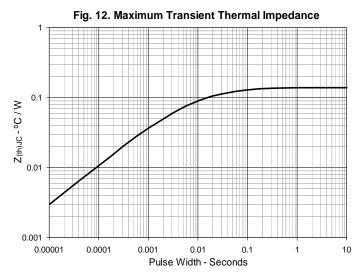












IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

